

$V_{\text{DRM}} = 4500 \text{ V}$
 $I_{\text{TGQM}} = 4000 \text{ A}$
 $I_{\text{TSM}} = 25 \times 10^3 \text{ A}$
 $V_{\text{T0}} = 2.1 \text{ V}$
 $r_{\text{T}} = 0.58 \text{ m}\Omega$
 $V_{\text{DcLink}} = 2800 \text{ V}$

Asymmetric Gate turn-off Thyristor

5SGA 40L4501

Doc. No. 5SYA1208-02 March 05

- Patented free-floating silicon technology
- Low on-state and switching losses
- Annular gate electrode
- Industry standard housing
- Cosmic radiation withstand rating

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Blocking

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak off-state voltage	V_{DRM}	$V_{\text{GR}} \geq 2 \text{ V}$			4500	V
Repetitive peak reverse voltage	V_{RRM}				17	V
Permanent DC voltage for 100 FIT failure rate	$V_{\text{DC-link}}$	Ambient cosmic radiation at sea level in open air.			2800	V

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak off-state current	I_{DRM}	$V_{\text{D}} = V_{\text{DRM}}, V_{\text{GR}} \geq 2 \text{ V}$			100	mA
Repetitive peak reverse current	I_{RRM}	$V_{\text{R}} = V_{\text{RRM}}, R_{\text{GK}} = \infty \Omega$			50	mA

Mechanical data

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_{m}		36	40	44	kN

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Pole-piece diameter	D_{p}	$\pm 0.1 \text{ mm}$		85		mm
Housing thickness	H		25.6		26.1	mm
Weight	m				1.5	kg
Surface creepage distance	D_{s}	Anode to Gate	33			mm
Air strike distance	D_{a}	Anode to Gate	14			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



GTO Data

On-state

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	$I_{T(AV)M}$	Half sine wave, $T_C = 85^\circ\text{C}$			1000	A
Max. RMS on-state current	$I_{T(RMS)}$				1570	A
Max. peak non-repetitive surge current	I_{TSM}	$t_p = 10\text{ ms}$, $T_{vj} = 125^\circ\text{C}$, sine wave After Surge: $V_D = V_R = 0\text{ V}$			25×10^3	A
Limiting load integral	$I^2 t$				3.1×10^6	A^2s
Max. peak non-repetitive surge current	I_{TSM}	$t_p = 1\text{ ms}$, $T_{vj} = 125^\circ\text{C}$, sine wave After Surge: $V_D = V_R = 0\text{ V}$			40×10^3	A
Limiting load integral	$I^2 t$				800×10^3	A^2s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_T	$I_T = 4000\text{ A}$, $T_{vj} = 125^\circ\text{C}$			4.4	V
Threshold voltage	$V_{(TO)}$	$T_{vj} = 125^\circ\text{C}$			2.1	V
Slope resistance	r_T	$I_T = 400 \dots 5000\text{ A}$			0.58	$\text{m}\Omega$
Holding current	I_H	$T_{vj} = 25^\circ\text{C}$			100	A

Turn-on switching

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di_T/dt_{cr}	$T_{vj} = 125^\circ\text{C}$, $f = 200\text{ Hz}$ $I_T = 4000\text{ A}$, $I_{GM} = 50\text{ A}$, $di_G/dt = 40\text{ A}/\mu\text{s}$, $f = 1\text{ Hz}$			500	$\text{A}/\mu\text{s}$
Critical rate of rise of on-state current	di_T/dt_{cr}				1000	$\text{A}/\mu\text{s}$
Min. on-time	t_{on}	$V_D = 0.5 V_{DRM}$, $T_{vj} = 125^\circ\text{C}$ $I_T = 4000\text{ A}$, $di/dt = 300\text{ A}/\mu\text{s}$, $I_{GM} = 50\text{ A}$, $di_G/dt = 40\text{ A}/\mu\text{s}$, $C_S = 6\text{ }\mu\text{F}$, $R_S = 5\text{ }\Omega$	100			μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Turn-on delay time	t_d	$V_D = 0.5 V_{DRM}$, $T_{vj} = 125^\circ\text{C}$ $I_T = 4000\text{ A}$, $di/dt = 300\text{ A}/\mu\text{s}$, $I_{GM} = 50\text{ A}$, $di_G/dt = 40\text{ A}/\mu\text{s}$, $C_S = 6\text{ }\mu\text{F}$, $R_S = 5\text{ }\Omega$			2.5	μs
Rise time	t_r				5	μs
Turn-on energy per pulse	E_{on}				3.3	J

Turn-off switching

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. controllable turn-off current	I_{TGQM}	$V_{DM} \leq V_{DRM}$, $di_{GQ}/dt = 40\text{ A}/\mu\text{s}$, $C_S = 6\text{ }\mu\text{F}$, $L_S \leq 0.3\text{ }\mu\text{H}$			4000	A
Min. off-time	t_{off}	$V_D = 0.5 V_{DRM}$, $T_{vj} = 125^\circ\text{C}$ $V_{DM} \leq V_{DRM}$, $di_{GQ}/dt = 40\text{ A}/\mu\text{s}$, $I_{TGQ} = I_{TGQM}$, $R_S = 5\text{ }\Omega$, $C_S = 6\text{ }\mu\text{F}$, $L_S = 0.3\text{ }\mu\text{H}$	100			μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Storage time	t_S	$V_D = 0.5 V_{DRM}$, $T_{vj} = 125^\circ\text{C}$ $V_{DM} \leq V_{DRM}$, $di_{GQ}/dt = 40\text{ A}/\mu\text{s}$, $I_{TGQ} = I_{TGQM}$, $R_S = 5\text{ }\Omega$, $C_S = 6\text{ }\mu\text{F}$, $L_S = 0.3\text{ }\mu\text{H}$			27	μs
Fall time	t_f				3	μs
Turn-on energy per pulse	E_{off}				14	J
Peak turn-off gate current	I_{GQM}				1100	A

Gate

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak reverse voltage	V_{GRM}				17	V
Repetitive peak reverse current	I_{GRM}	$V_{GR} = V_{GRM}$			50	mA

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate trigger voltage	V_{GT}	$T_{vj} = 25^{\circ}\text{C}$, $V_D = 24\text{ V}$, $R_A = 0.1\ \Omega$		1.2		V
Gate trigger current	I_{GT}			4		A

Thermal

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Junction operating temperature	T_{vj}		-40		125	$^{\circ}\text{C}$
Storage temperature range	T_{stg}		-40		125	$^{\circ}\text{C}$

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(j-c)}$	Double side cooled			11	K/kW
	$R_{th(j-c)A}$	Anode side cooled			20	K/kW
	$R_{th(j-c)C}$	Cathode side cooled			25	K/kW
Thermal resistance case to heatsink (Double side cooled)	$R_{th(c-h)}$	Single side cooled			6	K/kW
	$R_{th(c-h)}$	Double side cooled			3	K/kW

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i(1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i(\text{K/kW})$	7.313	1.974	1.218	0.501
$\tau_i(\text{s})$	0.5400	0.0939	0.0117	0.0036

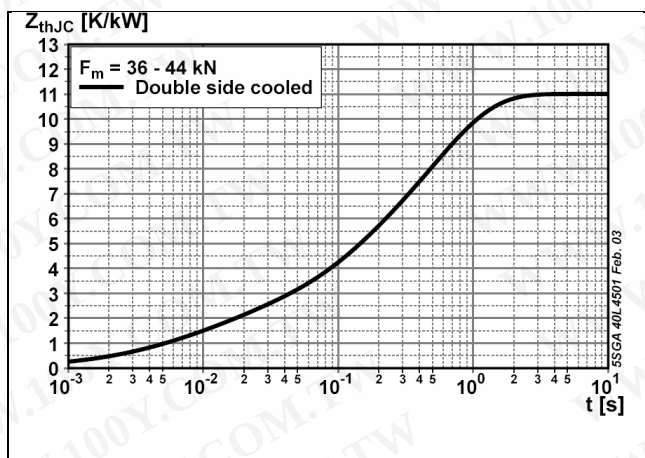


Fig. 1 Transient thermal impedance, junction to case

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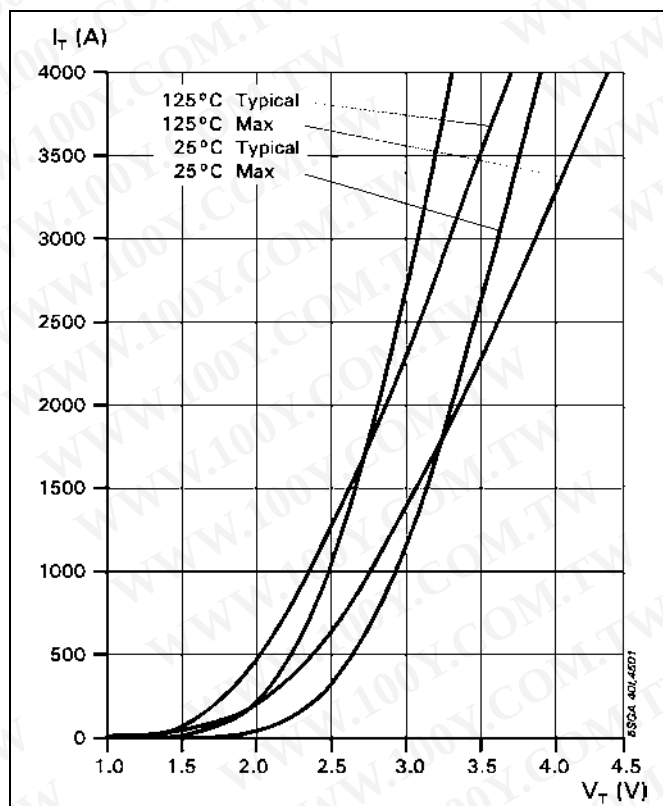


Fig. 2 On-state characteristics

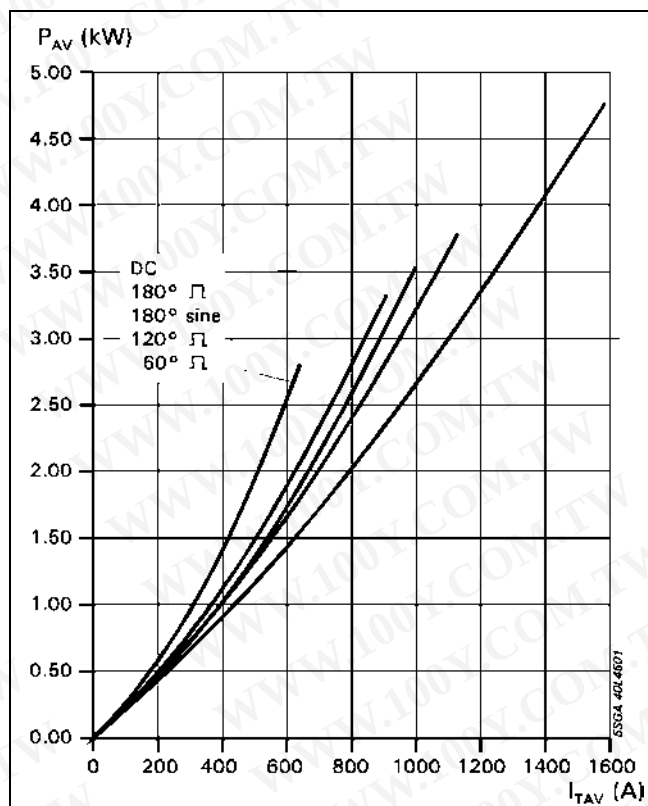


Fig. 3 Average on-state power dissipation vs. average on-state current

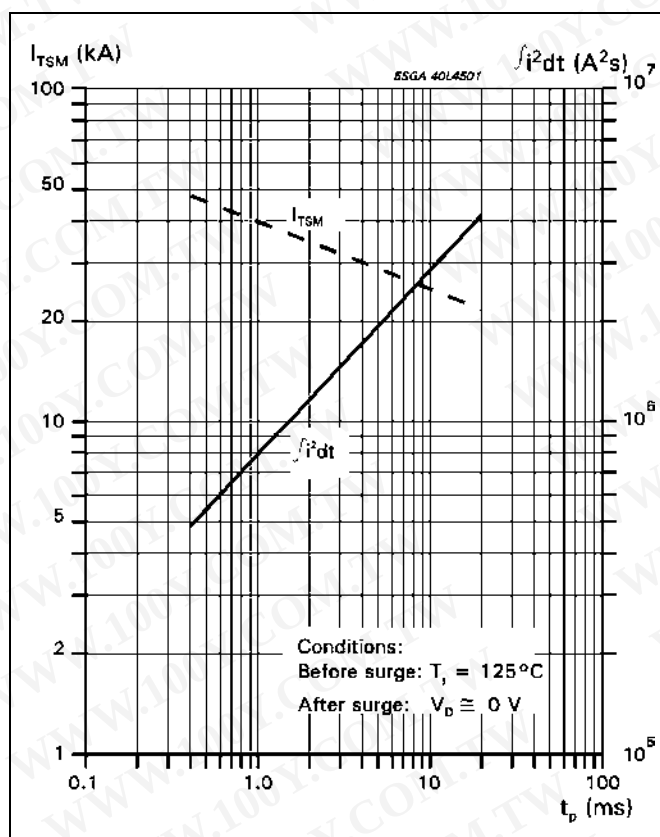


Fig. 4 Surge current and fusing integral vs. pulse width

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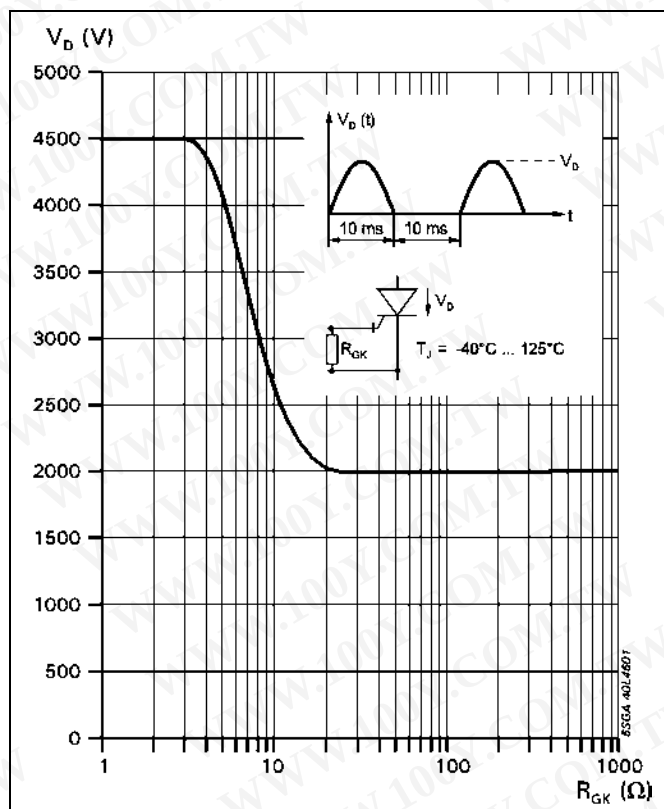


Fig. 5 Forward blocking voltage vs. gate-cathode resistance

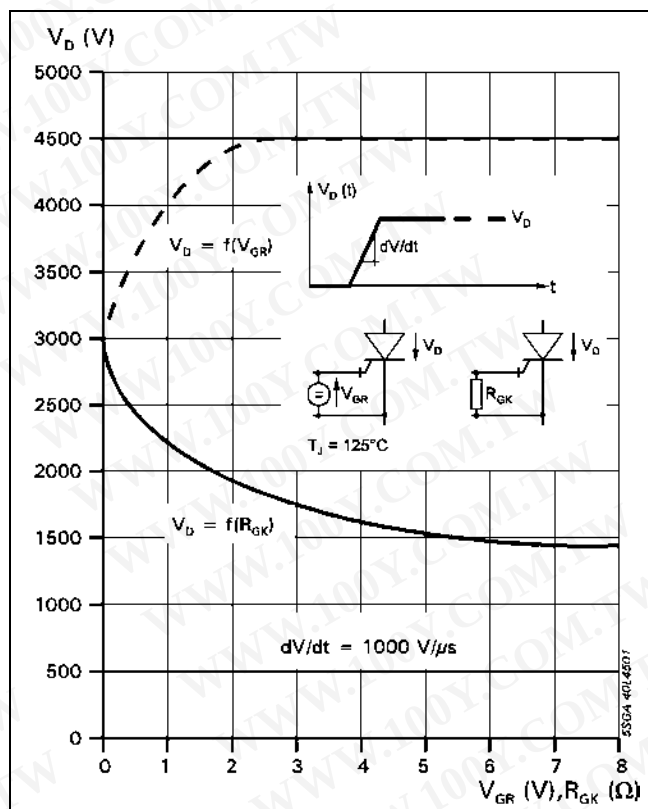


Fig. 6 Static dv/dt capability; forward blocking voltage vs. neg. gate voltage or gate cathode resistance

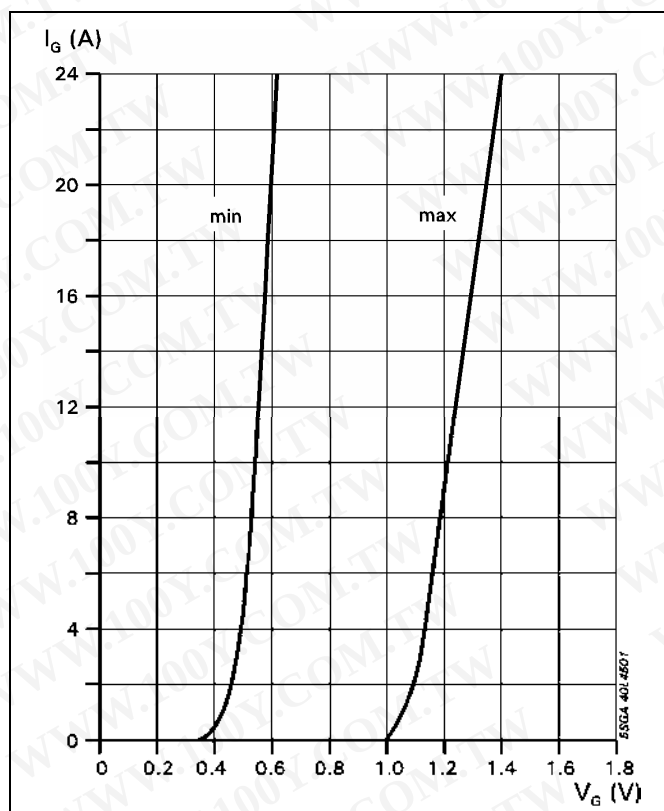


Fig. 7 Forward gate current vs. forward gate voltage

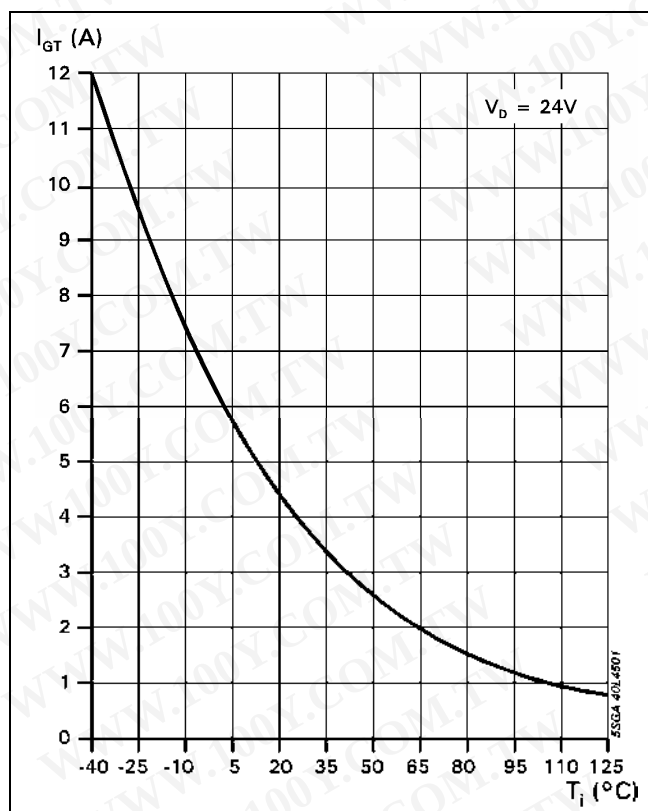


Fig. 8 Gate trigger current vs. junction temperature

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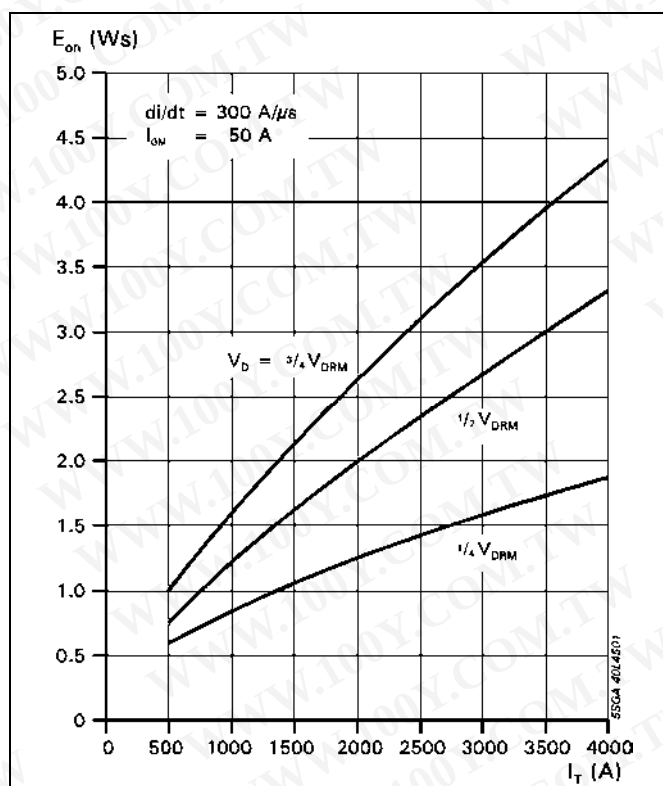


Fig. 9 Turn-on energy per pulse vs. on-state current and turn-on voltage

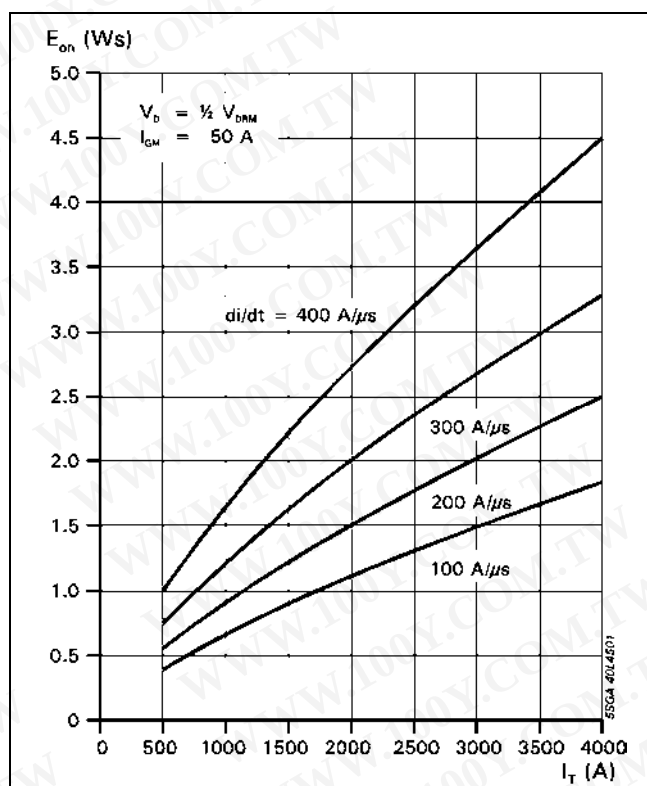


Fig. 10 Turn-on energy per pulse vs. on-state current and current rise rate

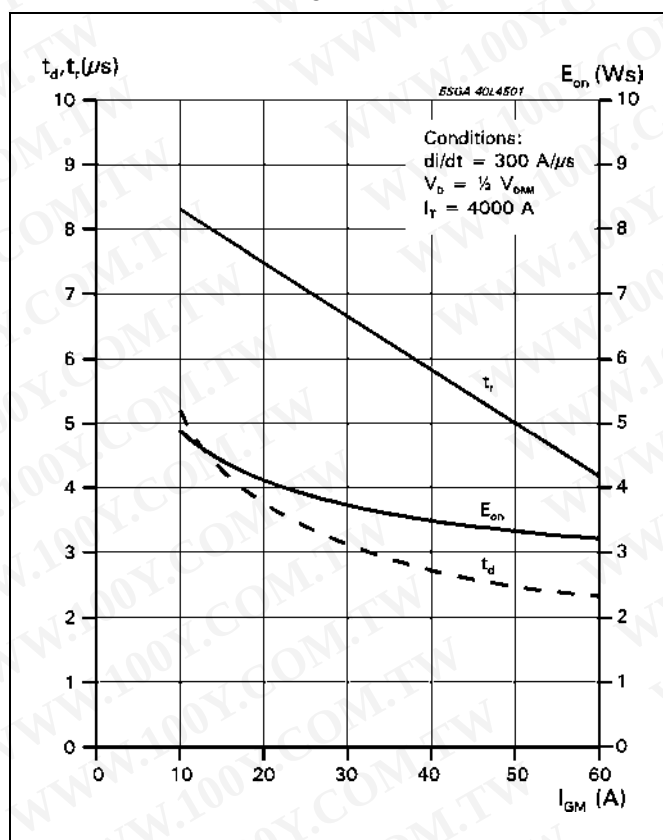


Fig. 11 Turn-on energy per pulse vs. on-state current and turn-on voltage

Common Test conditions:

$di_G/dt = 40 \text{ A}/\mu\text{s}$
 $C_S = 6 \mu\text{F}$
 $R_S = 5 \Omega$
 $T_J = 125^\circ\text{C}$

Definition of Turn-on energy:

$$E_{on} = \int_0^{20 \text{ ms}} V_D \cdot I_T dt \quad (t = 0, I_G = 0.1 \cdot I_{GM})$$

Definition of Turn-off energy:

$$E_{off} = \int_0^{40 \text{ ms}} V_D \cdot I_T dt \quad (t = 0, I_T = 0.9 \cdot I_{TQ})$$

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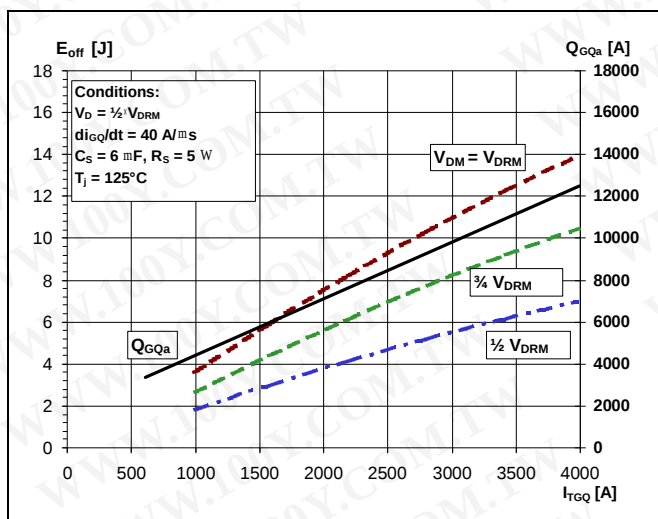


Fig. 12 Turn-off energy per pulse vs. turn-off current and peak turn-off voltage, extracted gate charge vs. turn-off current

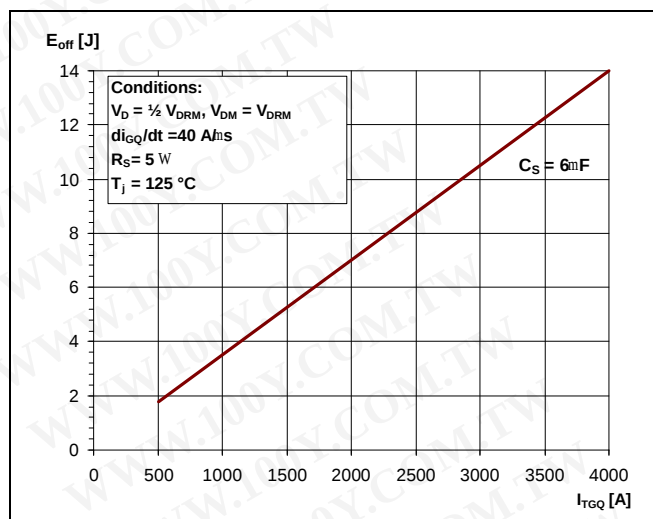


Fig. 13 Turn-off energy per pulse vs. turn-off current and snubber capacitance

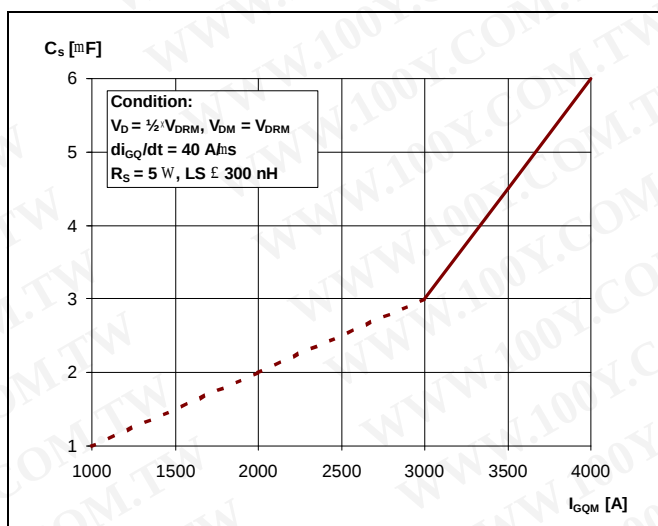


Fig. 14 Required snubber capacitor vs. max allowable turn-off current

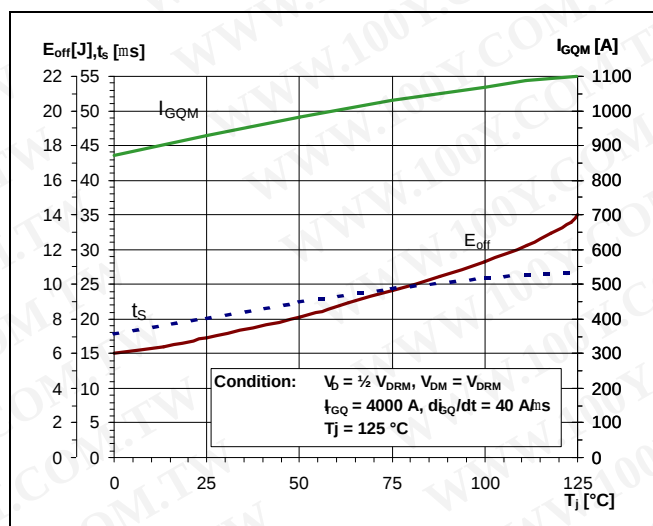


Fig. 15 Turn-off energy per pulse, storage time and peak turn-off gate current vs. junction temperature

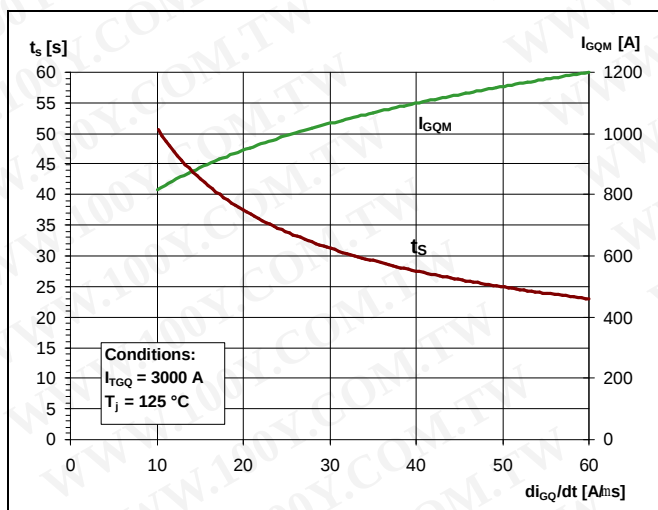


Fig. 16 Storage time and peak turn-off gate current vs. neg. gate current rise rate

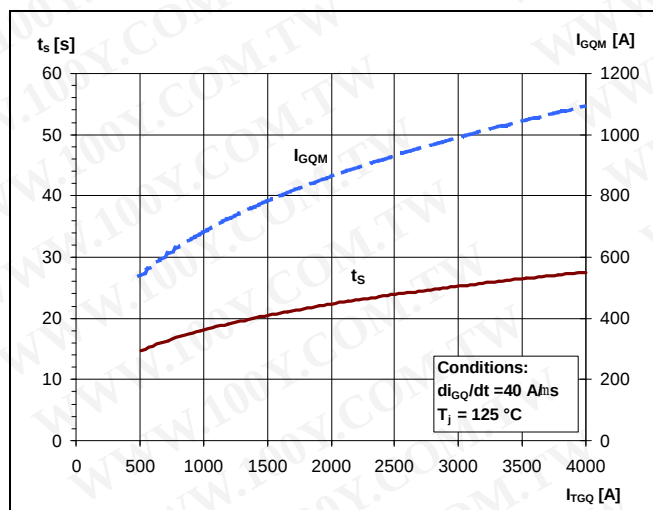


Fig. 17 Storage time and peak turn-off gate current vs. turn-off current

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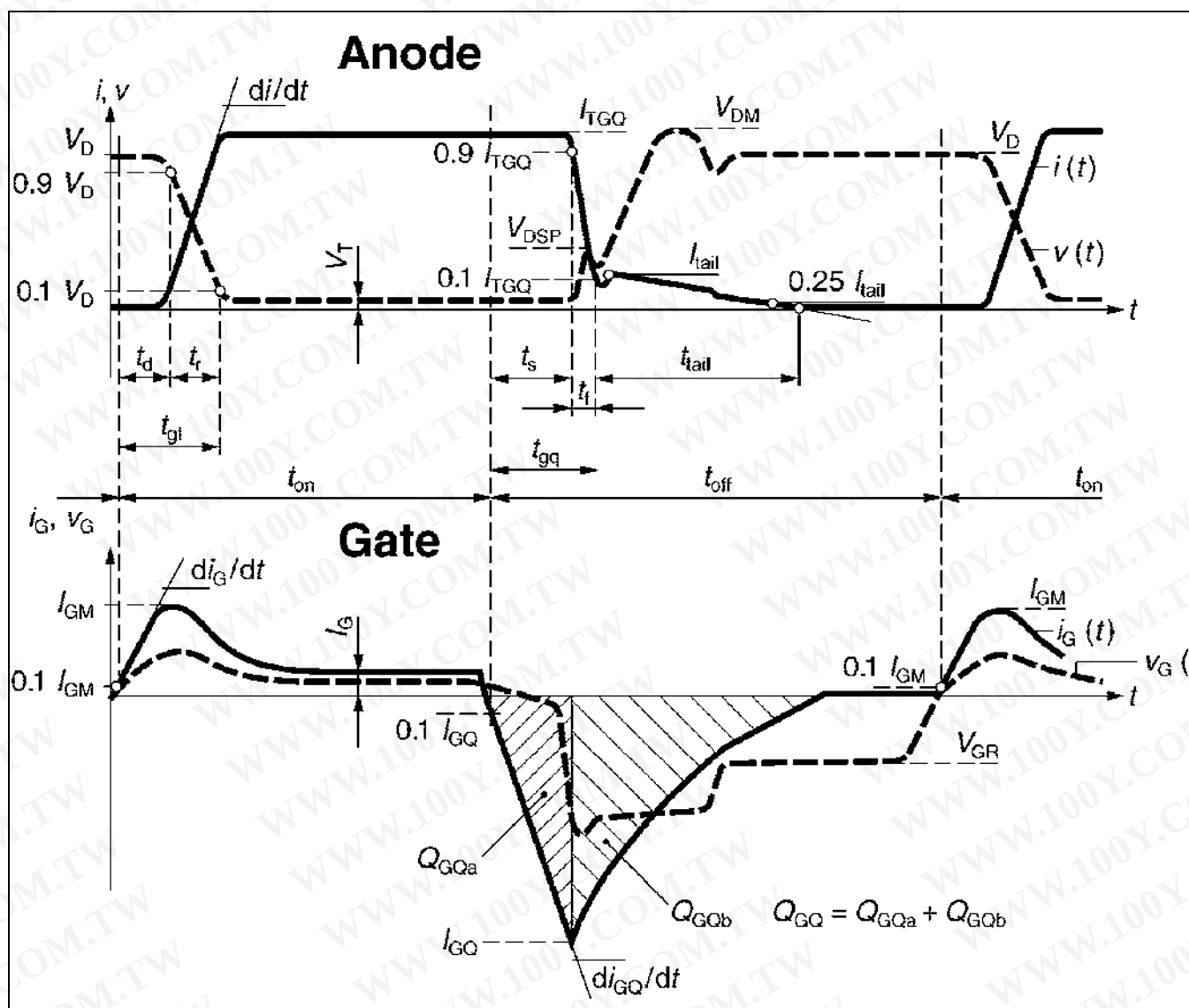


Fig. 18 General current and voltage waveforms with GTO-specific symbols

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Reverse avalanche capability

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